Accepted Manuscript

Molecular Dynamics Simulations of the Wetting Behavior of Carbon Nanotubes in Liquid Copper

Bryan T Susi, Jay F Tu

PII: \$0045-7930(18)30328-1

DOI: 10.1016/j.compfluid.2018.06.004

Reference: CAF 3921

To appear in: Computers and Fluids

Received date: 11 September 2017

Revised date: 4 June 2018 Accepted date: 11 June 2018



Please cite this article as: Bryan T Susi, Jay F Tu, Molecular Dynamics Simulations of the Wetting Behavior of Carbon Nanotubes in Liquid Copper, *Computers and Fluids* (2018), doi: 10.1016/j.compfluid.2018.06.004

This is a PDF file of an unedited manuscript that has been accepted for publication. As a service to our customers we are providing this early version of the manuscript. The manuscript will undergo copyediting, typesetting, and review of the resulting proof before it is published in its final form. Please note that during the production process errors may be discovered which could affect the content, and all legal disclaimers that apply to the journal pertain.

ACCEPTED MANUSCRIPT

Highlights

- Morse potential model proposed for copper-carbon interaction
- Macro-scale theory for wetting does not hold at carbon nanotube scales
- Liquid copper resistance to carbon nanotube submersion is rate dependent



Corresponding Author: Bryan T. Susi bsusi@ara.com 919-582-3414

Download English Version:

https://daneshyari.com/en/article/7155759

Download Persian Version:

https://daneshyari.com/article/7155759

<u>Daneshyari.com</u>